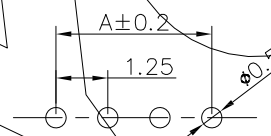
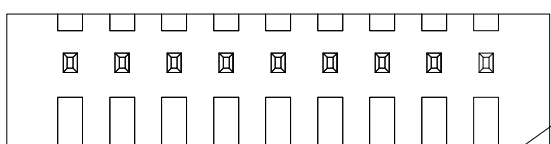
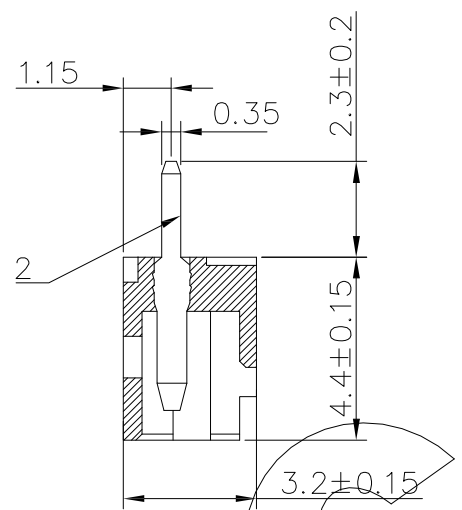
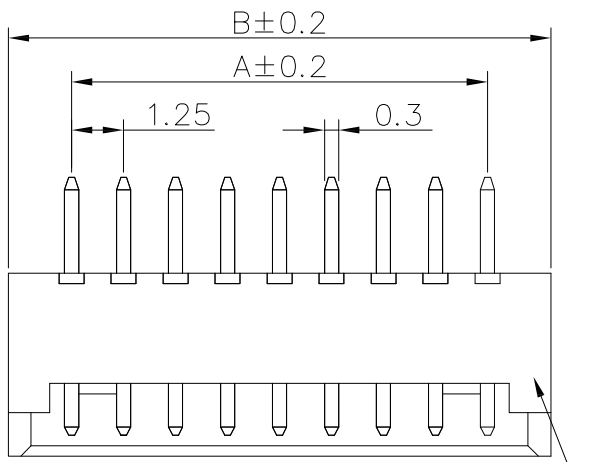
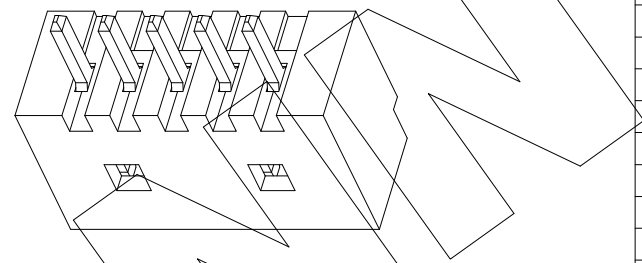


零件图	成品图	客户图
		○

REVISION DATA				
REV	ECN No.	DESCRIPTION	NAME	DATE
A0		NEW DRAWING	TIAN	2018-07-12



PCB Layout



poles	A	B
2	1.25	4.30
3	2.5	5.55
4	3.75	6.80
5	5.0	8.05
6	6.25	9.30
7	7.5	10.55
8	8.75	11.80
9	10.0	13.05
10	11.25	14.30
11	12.5	15.55
12	13.75	16.80
13	15.0	18.05
14	16.25	19.30
15	17.5	20.55
16	18.75	21.80

### Technical Data

Material:  
 Contact Material: Copper Alloy  
 Contact plating: Au or Sn Over Ni  
 Insulator Material: See the table, UL94 V-0

Electrical:  
 Rating current: 1Amps/contact max.  
 Rating voltage : 250 V AC/DC  
 Contact resistance: ≤20mΩ/contact  
 Insulation resistance: ≥500MΩ  
 Withstanding Voltage: 500V AC/minute

Mechanical:  
 Operating temperatures: Gold Plated: -55°C to +105°C  
 Tin plated: -40°C to +105°C  
 Soldering temperature: +260°C, max(PA66)  
 +220°C, max(PBT)

WF	C	D	11	XXX	XX	X	W	N	D004
Pitch(mm) A 2.5 B 2.0 C 1.25 D 3.96 E 2.54 F 3.0 G 1.0	Angel Options R 90° D 180° S SMT	Product Type 11 Single row	No. of Positions XXX Poles	Pln Plating G0 Gold Flash SN Sn	Insulator Material A PBT B PA66	W White			

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**DONGGUAN ENKANG ELECTRONICS TECHNOLOGY CO.,LTD**

TOLERANCE	DATE :	2018-07-12	TITLE:	PH 1.25 H4.40 180° DIP WAFER
ANGLE ±5°	DRAWN :	TIAN	PART NO: WFCDD11XXXXXXND004	
X.XXX ±0.15	CHECKED :			
X.XX ±0.25	APPROVED :			
X.X ±0.40	PROJECTON		REV: A0	UNIT: mm
X. ±0.50			SCALE: 1:1	SIZE: A4
			PAGE: 1/1	